



5. PCB'S MARKED "RoHS COMPLIANT" HAVE BEEN FABRICATED USING ENIG PLATING PROCESS ON SOLDER PADS PER IPC-4552.
4. PCB TO BE ASSEMBLED USING RoHS COMPLIANT PROCESSES, COMPONENTS AND MATERIALS.
3. UNUSED COMPONENT HOLES AND VIAS MAY BE SOLDER FILLED EXCEPT WHERE OTHERWISE SPECIFIED
2. MAX. LEAD TRIM LENGTH 0.060" EXCEPT WHERE OTHERWISE SPECIFIED
1. ASSEMBLE IN ACCORDANCE WITH IPC-610A, CLASS 2

NOTES: UNLESS OTHERWISE SPECIFIED

		UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES ARE:			DEPT. MANUFACTURING		CS ELECTRONICS			
		FRACTIONS ±	DECIMALS .XX± .XXX±	ANGLES ±	APPROVAL	DATE	TITLE			
		MATERIAL			DRAWN BY IDS		ASSEMBLY ADP-4200			
					DATE 1/31/06					
		FINISH			DOC. CONTROL		SIZE A			
					DRAWING NUMBER 011806					
NEXT ASSY	USED ON	DO NOT SCALE DRAWING			ENGINEERING		REV. NC			
					MANUFACTURING					
APPLICATION					PURCHASING		FILE 011806NC_ASSY.DWG		SCALE 2:1	SHEET 1 OF 1